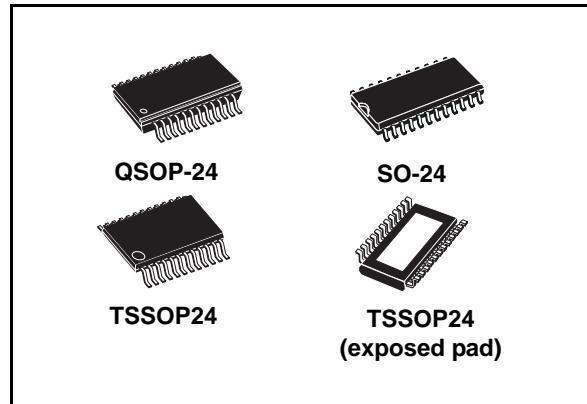


Low voltage 16-bit constant current LED sink driver

Features

- Low voltage power supply down to 3 V
- 16 constant current output channels
- Adjustable output current through external resistor
- Serial data IN/parallel data OUT
- Can be driven by a 3.3 V microcontroller
- Output current: 5-100 mA
- Max clock frequency 30 MHz
- ESD protection 2.5 kV HBM, 200 V MM



Description

The STP16CP05 is a monolithic, low voltage, low current power 16-bit shift register designed for LED panel displays. The STP16CP05 contains a 16-bit serial-in, parallel-out shift register that feeds a 16-bit, D-type storage register. In the output stage, sixteen regulated current sources provide from 5 mA to 100 mA constant current to drive the LEDs.

The output current setup time is 40 ns (typ), thus improving the system performance.

The LEDs' brightness can be controlled by using an external resistor to adjust the STP16CP05 output current.

The STP16CP05 guarantees a 20 V output driving capability, allowing users to connect more LEDs in series. The high clock frequency, 30 MHz, makes the device suitable for high data rate transmission. The 3.3 V voltage supply is useful in applications that interface with a 3.3 V micro controller.

Table 1. Device summary

| Order codes | Package | Packaging |
|---------------|---------------------|---------------------|
| STP16CP05MTR | SO-24 | 1000 parts per reel |
| STP16CP05TTR | TSSOP24 | 2500 parts per reel |
| STP16CP05XTTR | TSSOP24 exposed pad | 2500 parts per reel |
| STP16CP05PTR | QSOP-24 | 2500 parts per reel |

Contents

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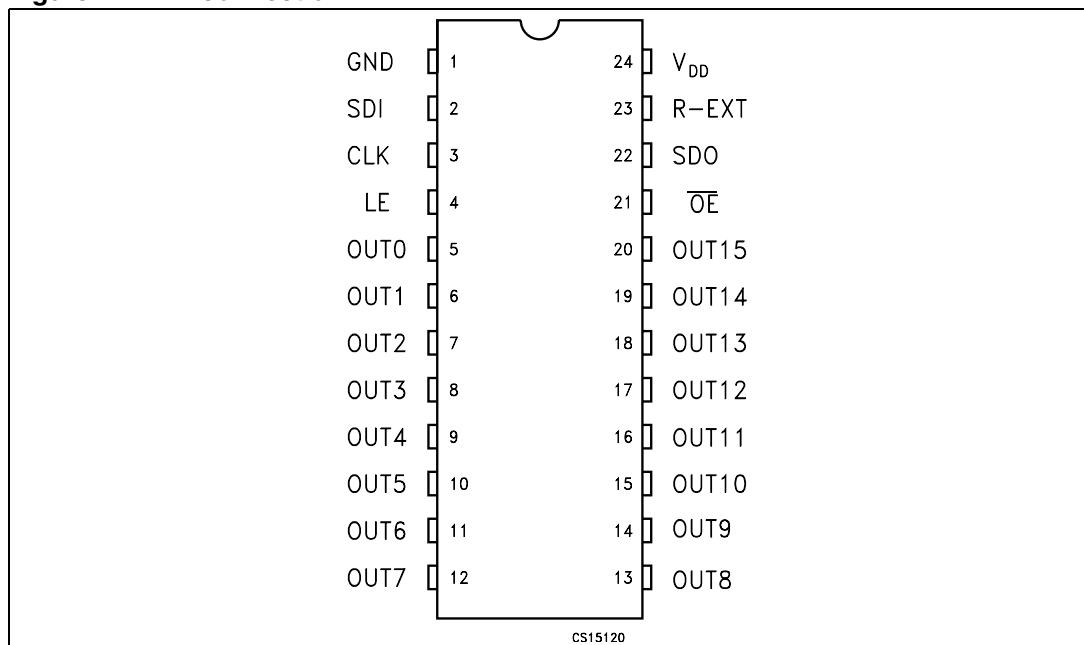
1 Summary description

Table 2. Typical current accuracy

| Output voltage | Current accuracy | | Output current | V_{DD} | Temperature |
|----------------------|------------------|-------------|--------------------------------------|--------------|-------------|
| | Between bits | Between ICs | | | |
| $\geq 1.3 \text{ V}$ | $\pm 1.5 \%$ | $\pm 5 \%$ | $\geq 20 \text{ to } 100 \text{ mA}$ | 3.3 V to 5 V | 25 °C |

1.1 Pin connection and description

Figure 2. Pin connection



Note: *The exposed pad is electrically not connected*

Table 3. Pin description

| Pin N° | Symbol | Name and function |
|--------|-----------------|-------------------------------------------------------------------------|
| 1 | GND | Ground terminal |
| 2 | SDI | Serial data input terminal |
| 3 | CLK | Clock input terminal |
| 4 | LE | Latch input terminal |
| 5-20 | OUT 0-15 | Output terminal |
| 21 | \overline{OE} | Input terminal of output enable (active low) |
| 22 | SDO | Serial data out terminal |
| 23 | R-EXT | Input terminal of an external resistor for constant current programming |
| 24 | V_{DD} | Supply voltage terminal |

2 Electrical ratings

2.1 Absolute maximum ratings

Stressing the device above the rating listed in the “absolute maximum ratings” table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-----------|----------------------|----------------------|------|
| V_{DD} | Supply voltage | 0 to 7 | V |
| V_O | Output voltage | -0.5 to 20 | V |
| I_O | Output current | 100 | mA |
| V_I | Input voltage | -0.4 to $V_{DD}+0.4$ | V |
| I_{GND} | GND terminal current | 1600 | mA |
| f_{CLK} | Clock frequency | 50 | MHz |

2.2 Thermal data

Table 5. Thermal data

| Symbol | Parameter | Value | Unit | |
|------------|----------------------------------|------------------------------------|------|------|
| T_{OPR} | Operating temperature range | -40 to +125 | °C | |
| T_{STG} | Storage temperature range | -55 to +150 | °C | |
| R_{thJC} | Thermal resistance junction-case | SO-24 | 60 | °C/W |
| | | TSSOP24 | 85 | °C/W |
| | | TSSOP24 ⁽¹⁾ exposed pad | 37.5 | °C/W |
| | | QSOP-24 | 72 | °C/W |

1. The exposed pad should be soldered directly to the PCB to realize the thermal benefits.

2.3 Recommended operating conditions

Table 6. Recommended operating conditions at 25 °C

| Symbol | Parameter | Test conditions | Min | Typ | Max | Unit |
|----------------|-----------------------------|----------------------------------|--------------|-----|--------------|------|
| V_{DD} | Supply voltage | | 3.0 | | 5.5 | V |
| V_O | Output voltage | | | | 20 | V |
| I_O | Output current | OUTn | 3 | | 100 | mA |
| I_{OH} | Output current | SERIAL-OUT | | | +1 | mA |
| I_{OL} | Output current | SERIAL-OUT | | | -1 | mA |
| V_{IH} | Input voltage | | 0.7 V_{DD} | | $V_{DD}+0.3$ | V |
| V_{IL} | Input voltage | | -0.3 | | 0.3 V_{DD} | V |
| t_{wLAT} | LE pulse width | $V_{DD} = 3.3V$ to 5.0V | 20 | | | ns |
| t_{wCLK} | CLK pulse width | | 16 | | | ns |
| t_{wEN} | \overline{OE} pulse width | | 200 | | | ns |
| $t_{SETUP(D)}$ | Setup time for DATA | | 20 | | | ns |
| $t_{HOLD(D)}$ | Hold time for DATA | | 15 | | | ns |
| $t_{SETUP(L)}$ | Setup time for LATCH | | 15 | | | ns |
| f_{CLK} | Clock frequency | Cascade operation ⁽¹⁾ | | | 30 | MHz |

1. If the device is connected in cascade, it may not be possible achieve the maximum data transfer. Please considered the timings carefully.

3 Electrical characteristics

Table 7. Electrical characteristics
($V_{DD} = 3.3\text{ V}$ to 5 V , $T = 25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Test conditions | Min | Typ | Max | Unit |
|------------------|--------------------------------------------------------|----------------------------------------------------|----------------------|-----------|-------------|---------------|
| V_{IH} | Input voltage high level | | $0.7V_{DD}$ | | V_{DD} | V |
| V_{IL} | Input voltage low level | | GND | | $0.3V_{DD}$ | V |
| I_{OH} | Output leakage current | $V_{OH} = 20\text{ V}$ | | | 10 | μA |
| V_{OL} | Output voltage (Serial-OUT) | $I_{OL} = 1\text{ mA}$ | | | 0.4 | V |
| V_{OH} | Output voltage (Serial-OUT) | $I_{OH} = -1\text{ mA}$ | $V_{DD}-0.4\text{V}$ | | | V |
| I_{OL1} | Output current | $V_O = 0.3\text{ V}, R_{ext} = 3.9\text{ k}\Omega$ | 4.25 | 5 | 5.75 | mA |
| I_{OL2} | | $V_O = 0.3\text{ V}, R_{ext} = 970\text{ }\Omega$ | 19 | 20 | 21 | |
| I_{OL3} | | $V_O = 1.3\text{ V}, R_{ext} = 190\text{ }\Omega$ | 96 | 100 | 104 | |
| ΔI_{OL1} | Output current error between bit (All Output ON) | $V_O = 0.3\text{ V} R_{EXT} = 3.9\text{ k}\Omega$ | | ± 5 | ± 8 | % |
| ΔI_{OL2} | | $V_O = 0.3\text{ V} R_{EXT} = 970\text{ }\Omega$ | | ± 1.5 | ± 3 | |
| ΔI_{OL3} | | $V_O = 1.3\text{ V} R_{EXT} = 190\text{ }\Omega$ | | ± 1.2 | ± 3 | |
| $R_{SIN(up)}$ | Pull-up resistor | | 150 | 300 | 600 | k Ω |
| $R_{SIN(down)}$ | Pull-down resistor | | 100 | 200 | 400 | k Ω |
| $I_{DD(OFF1)}$ | Supply current (OFF) | $R_{EXT} = 970\text{ }\Omega$ OUT 0 to 15 = OFF | | 4 | | mA |
| $I_{DD(OFF2)}$ | | $R_{EXT} = 240\text{ }\Omega$ OUT 0 to 15 = OFF | | 11.2 | | |
| $I_{DD(ON1)}$ | Supply current (ON) | $R_{EXT} = 970\text{ }\Omega$ OUT 0 to 15 = ON | | 4.5 | | |
| $I_{DD(ON2)}$ | | $R_{EXT} = 240\text{ }\Omega$ OUT 0 to 15 = ON | | 11.7 | | |
| Thermal | Thermal protection | | | 170 | | °C |

Table 8. Switching characteristics ($V_{DD} = 5$ V, $T = 25$ °C, unless otherwise specified.)

| Symbol | Parameter | Test conditions | | Min | Typ | Max | Unit |
|------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------|------------------|-----|-----|------|------|
| t_{PLH1} | Propagation delay time, CLK- \overline{OUT}_n , LE = H, $\overline{OE} = L$ | $V_{IH} = V_{DD}$ $V_{IL} = GND$ $I_O = 20$ mA $R_{EXT} = 1$ kΩ | $V_{DD} = 3.3$ V | 62 | 90 | | ns |
| t_{PLH2} | Propagation delay time, LE- \overline{OUT}_n , $\overline{OE} = L$ | | $V_{DD} = 5$ V | 39 | 55 | | |
| t_{PLH3} | Propagation delay time, \overline{OE} - \overline{OUT}_n , LE = H | | $V_{DD} = 3.3$ V | 60 | 88 | | ns |
| t_{PLH} | Propagation delay time, CLK-SDO | | $V_{DD} = 5$ V | 41 | 57 | | |
| t_{PHL1} | Propagation delay time, CLK- \overline{OUT}_n , LE = H, $\overline{OE} = L$ | | $V_{DD} = 3.3$ V | 65 | 95 | | ns |
| t_{PHL2} | Propagation delay time, LE- \overline{OUT}_n , $\overline{OE} = L$ | | $V_{DD} = 5$ V | 43 | 60 | | |
| t_{PHL3} | Propagation delay time, \overline{OE} - \overline{OUT}_n , LE = H | | $V_{DD} = 3.3$ V | 8 | 12 | | ns |
| t_{PHL} | Propagation delay time, CLK-SDO | | $V_{DD} = 5$ V | 5 | 7 | | |
| t_{ON} | Output rise time 10~90 % of voltage waveform | | $V_{DD} = 3.3$ V | 18 | 25 | | |
| t_{OFF} | Output fall time 90~10 % of voltage waveform | | $V_{DD} = 5$ V | 16 | 22 | | |
| t_r | CLK rise time (1) | | $V_{DD} = 3.3$ V | 19 | 25 | | ns |
| t_f | CLK fall time (1) | | $V_{DD} = 5$ V | 15 | 21 | | |
| | | | $V_{DD} = 3.3$ V | 23 | 31 | | ns |
| | | | $V_{DD} = 5$ V | 20 | 27 | | |
| | | | $V_{DD} = 3.3$ V | 8.5 | 13 | | ns |
| | | | $V_{DD} = 5$ V | 5.5 | 8 | | |
| | | | $V_{DD} = 3.3$ V | 100 | 130 | | ns |
| | | | $V_{DD} = 5$ V | 22 | 35 | | |
| | | | $V_{DD} = 3.3$ V | 13 | 18 | | ns |
| | | | $V_{DD} = 5$ V | 18 | 25 | | |
| | | | | | | 5000 | ns |
| | | | | | | 5000 | ns |

1. In order to achieve high cascade data transfer, please consider tr/tf timings carefully.

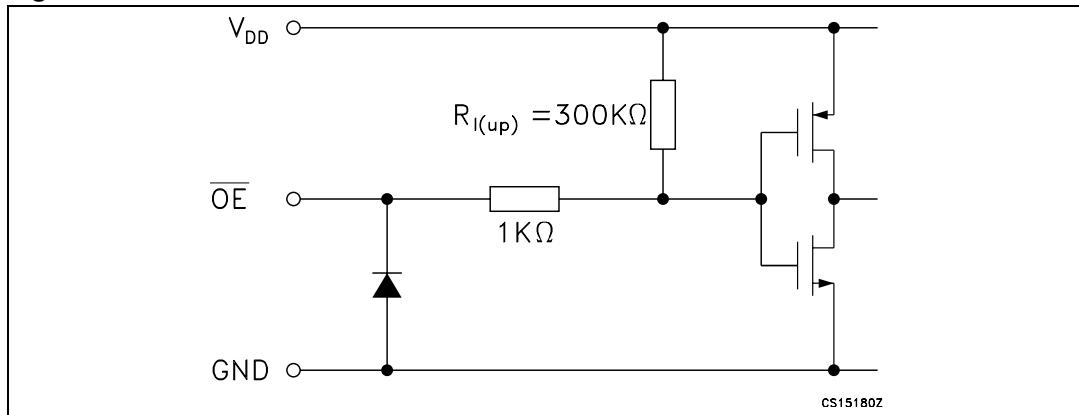
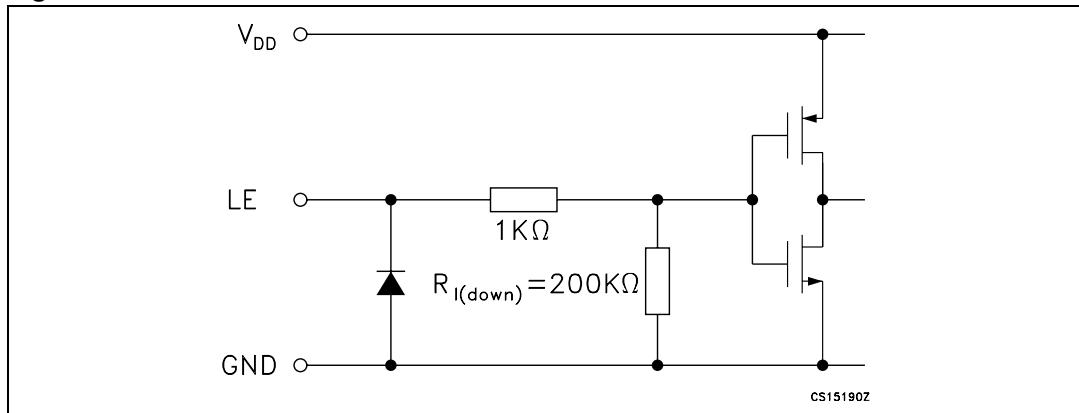
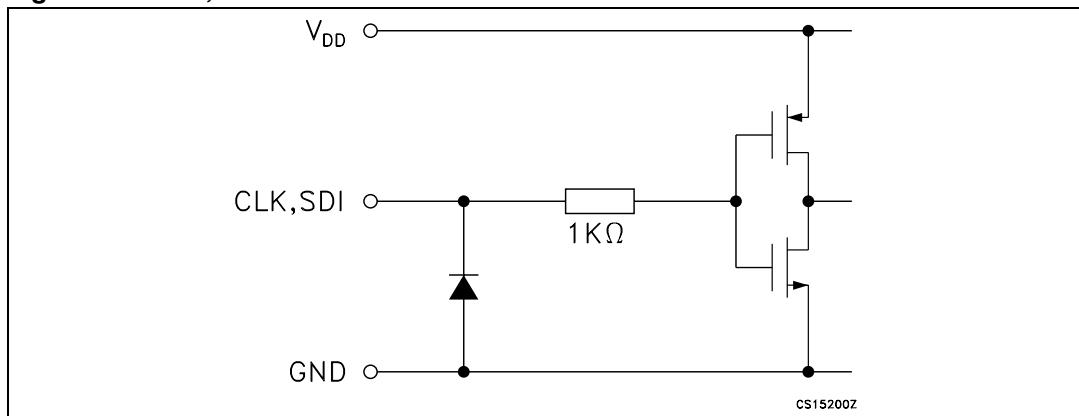
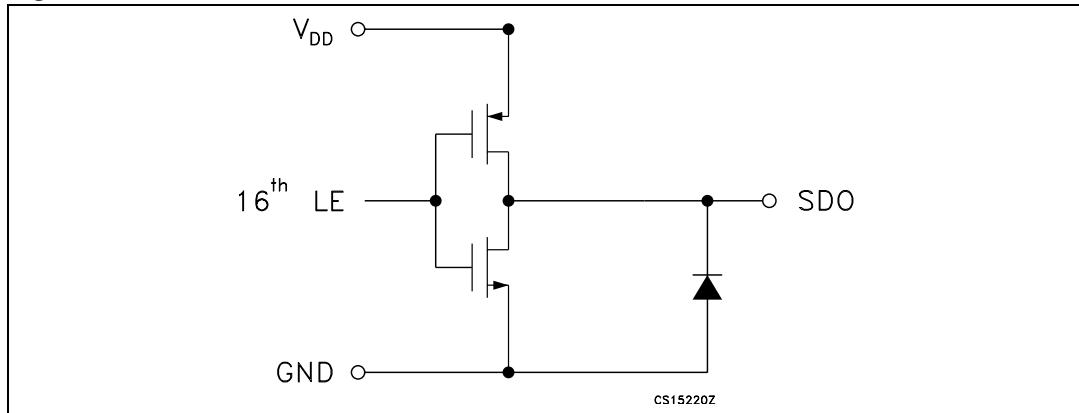
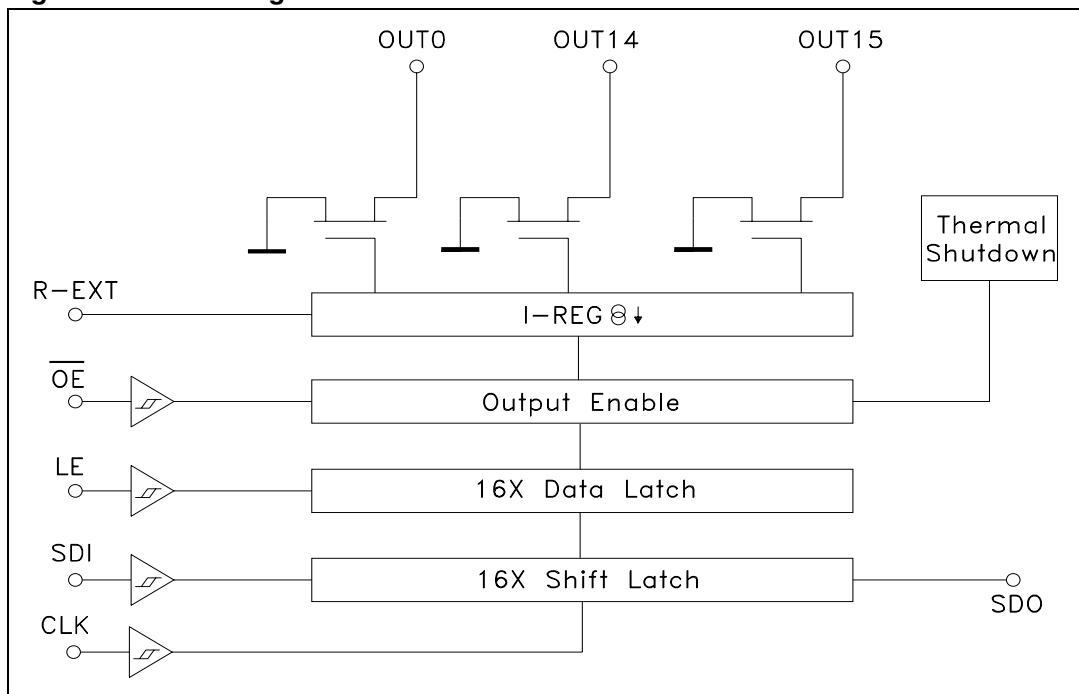
4**Equivalent circuit and outputs****Figure 3. \overline{OE} terminal****Figure 4. LE terminal****Figure 5. CLK, SDI terminal**

Figure 6. SDO terminal**Figure 7. Block diagram**

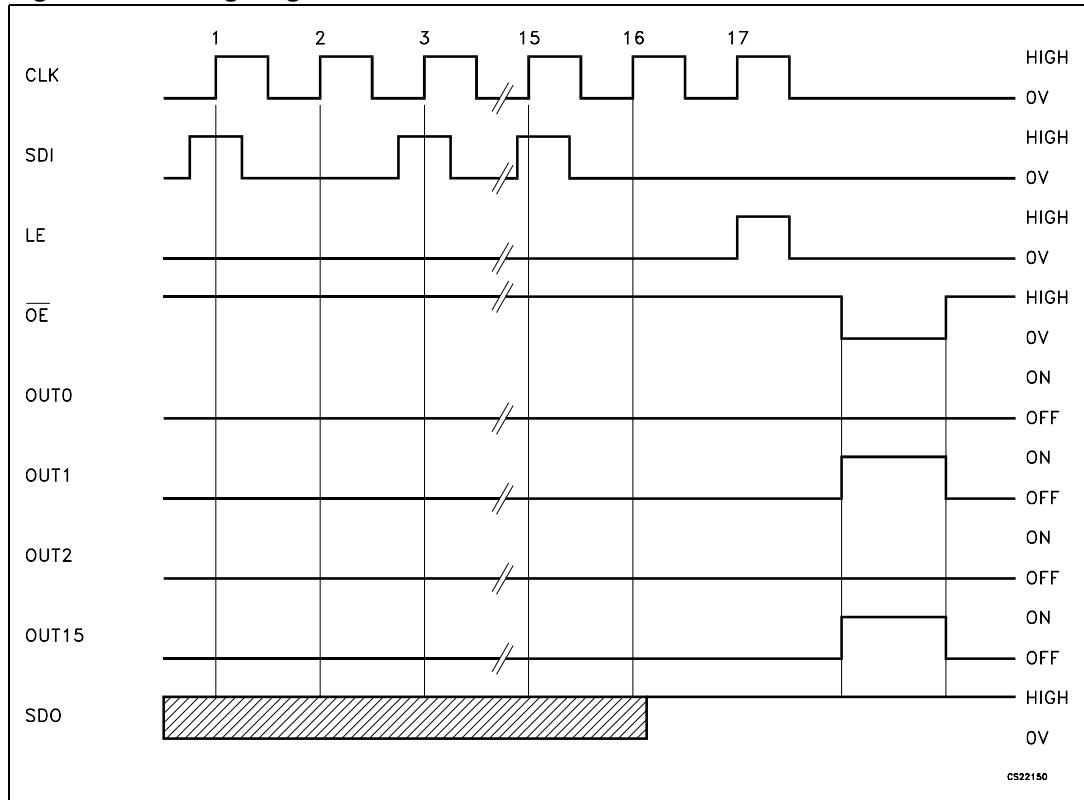
5 Timing diagrams

Table 9. Truth table

| CLOCK | LE | \overline{OE} | Serial-IN | OUT0 OUT7 OUT15 | SDO |
|-------|----|-----------------|-----------|-----------------------------------|---------|
| — | H | L | Dn | Dn Dn - 7 Dn - 15 | Dn - 15 |
| — | L | L | Dn + 1 | No change | Dn - 14 |
| — | H | L | Dn + 2 | Dn + 2 Dn - 5 Dn - 13 | Dn - 13 |
| — | X | L | Dn + 3 | Dn + 2 Dn - 5 Dn - 13 | Dn - 13 |
| — | X | H | Dn + 3 | OFF | Dn - 13 |

Note: $OUT_n = ON$ when $D_n = H$ $OUT_n = OFF$ when $D_n = L$

Figure 8. Timing diagram



Note: The latches circuit holds data when the LE terminal is Low.

- 1 When LE terminal is at high level, latch circuit does not hold the data it passes from the input to the output.
- 2 When \overline{OE} terminal is at low level, output terminals OUT0 to OUT15 respond to the data, either ON or OFF.
- 3 When \overline{OE} terminal is at high level, it switches off all the data on the output terminal.

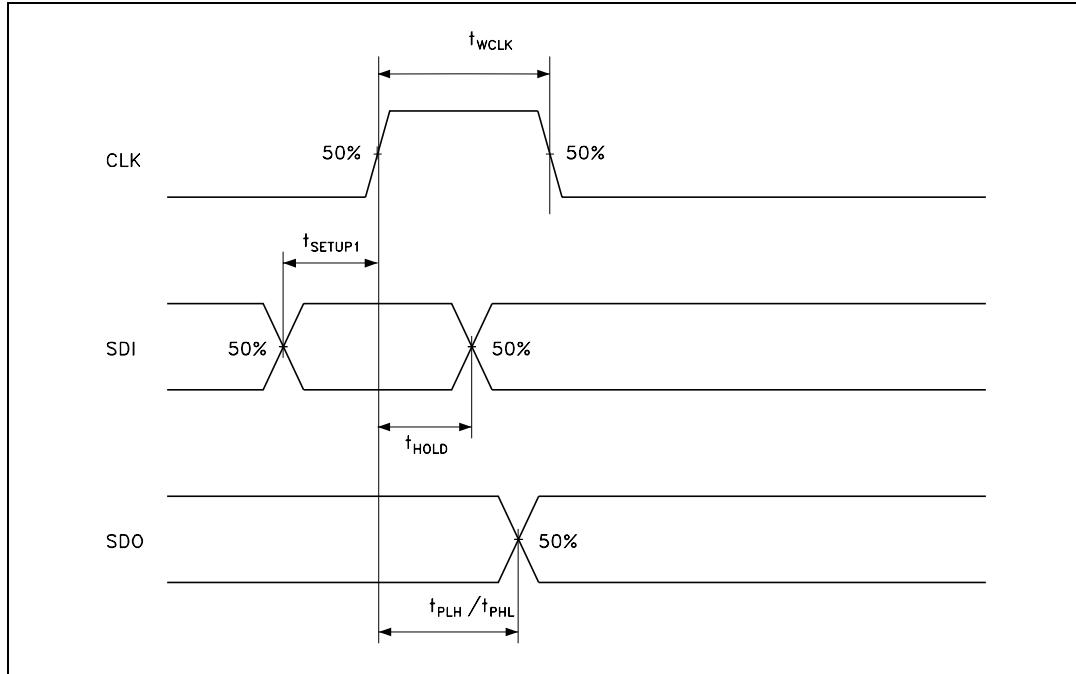
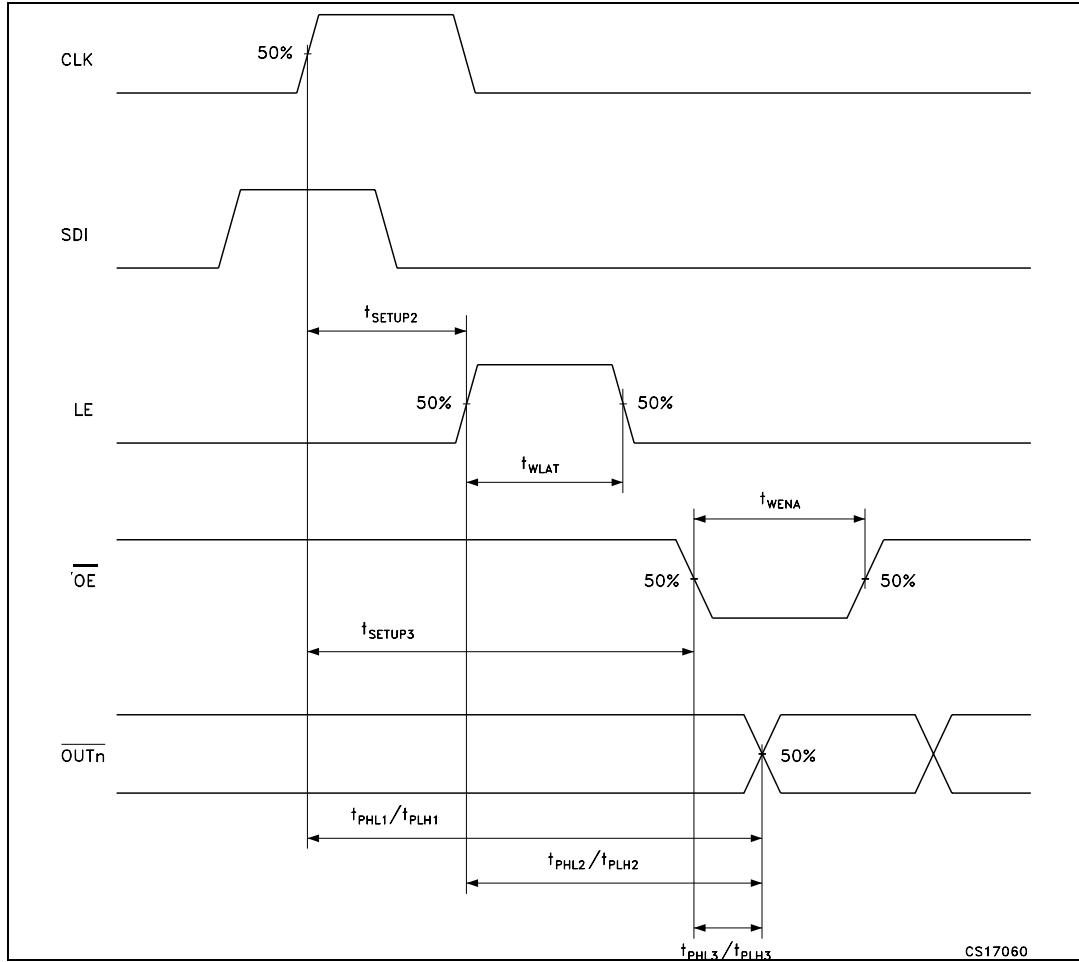
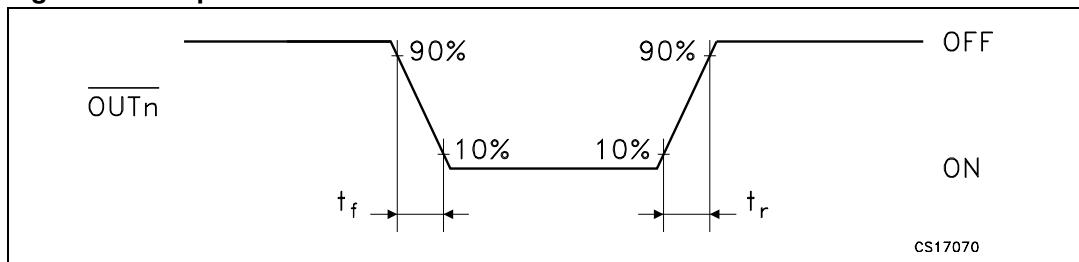
Figure 9. Clock, serial-in, serial-out

Figure 10. Clock, serial-in, latch, enable, outputs**Figure 11. Outputs**

6 Typical characteristics

Figure 12. Output current-R_{EXT} resistor

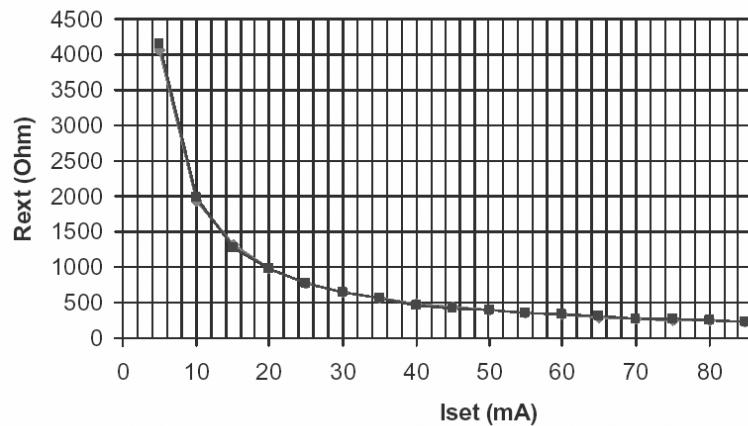


Table 10. Output current-R_{EXT} resistor

| Rext (Ω) | Output current (mA) |
|-------------------|---------------------|
| 976 | 20 |
| 780 | 25 |
| 652 | 30 |
| 560 | 35 |
| 488 | 40 |
| 433 | 45 |
| 389 | 50 |
| 354 | 55 |
| 325 | 60 |
| 300 | 65 |
| 278 | 70 |
| 259 | 75 |
| 241 | 80 |
| 229 | 85 |
| 215 | 90 |

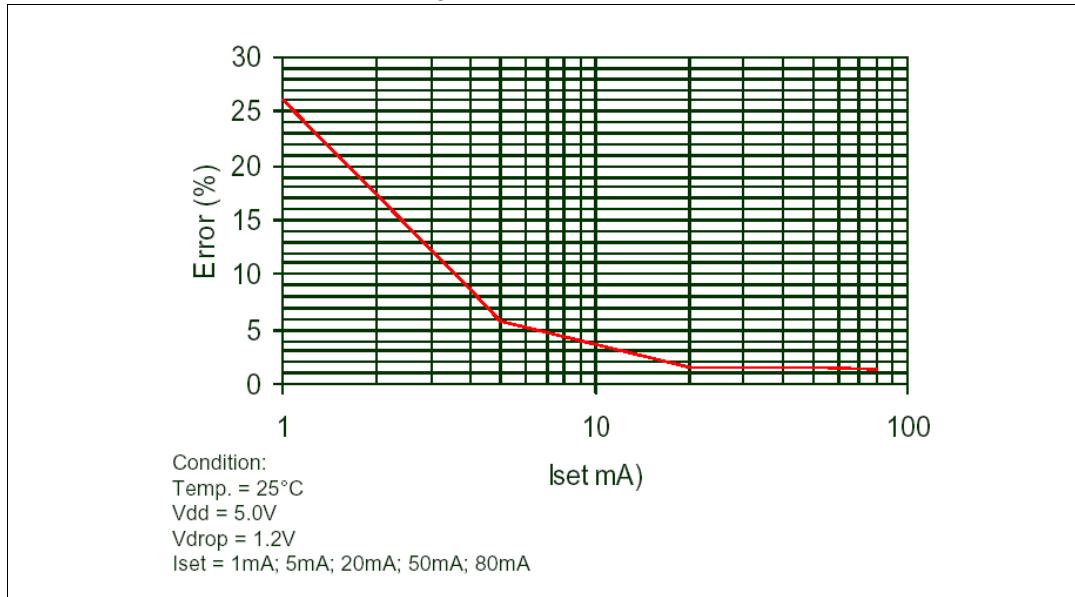
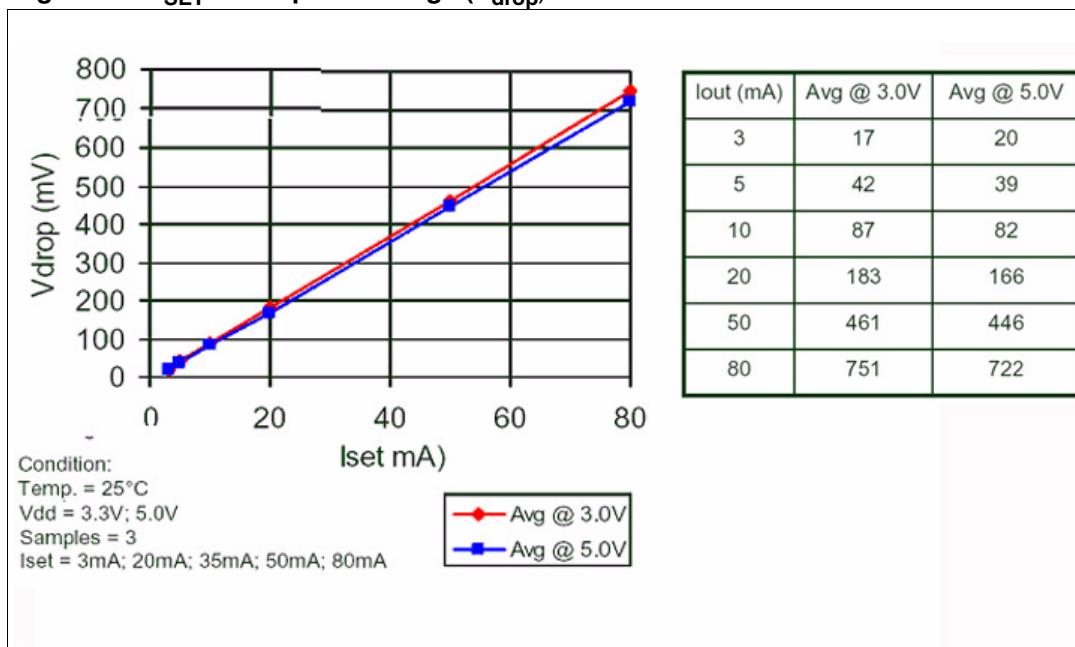
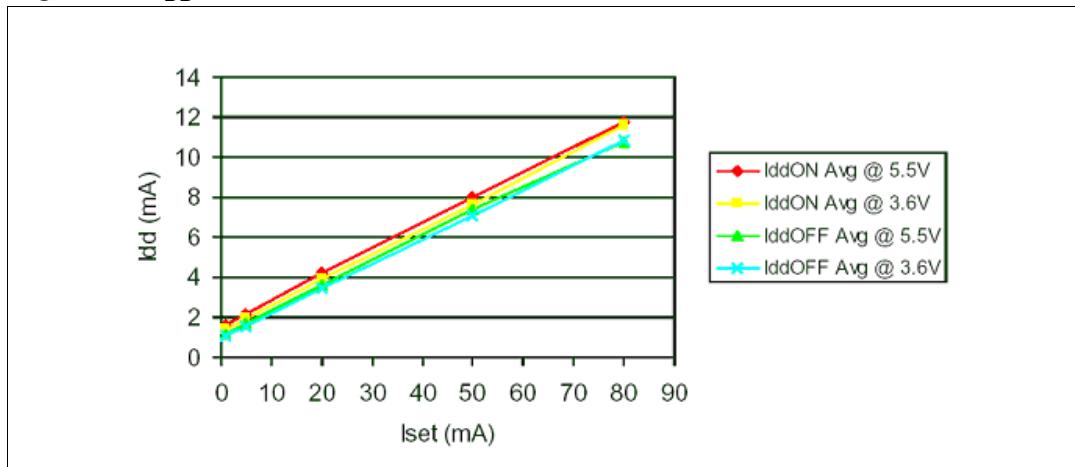
Figure 13. Output current vs $\pm \Delta I_{OL}(\%)$ **Figure 14. I_{SET} vs drop out voltage (V_{drop})**

Figure 15. I_{DD} ON\OFF

7 Test circuit

Figure 16. DC characteristic

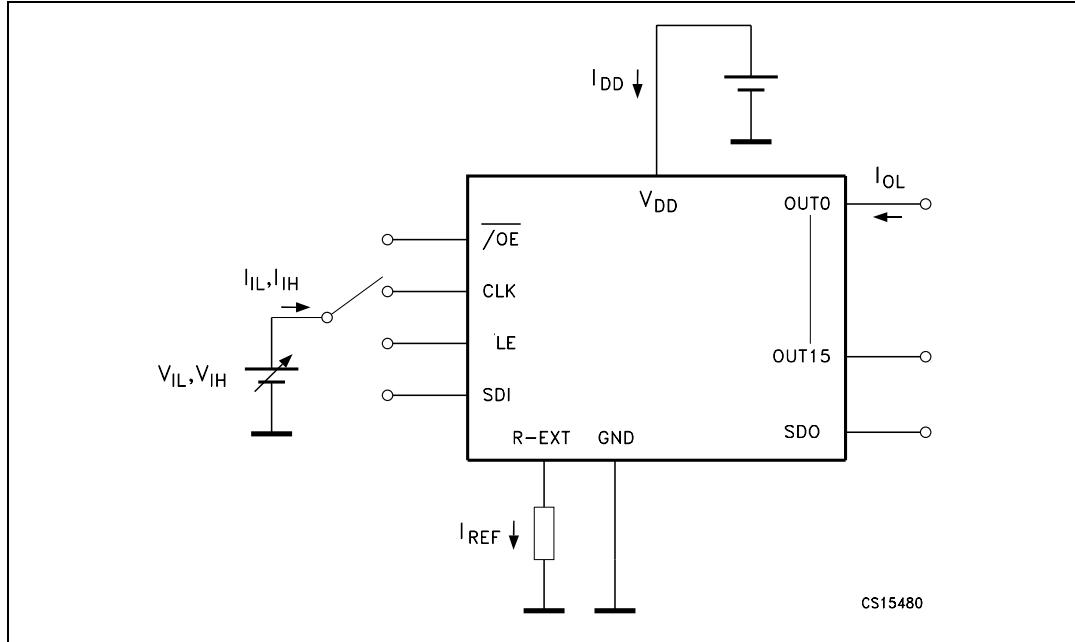


Figure 17. AC characteristic

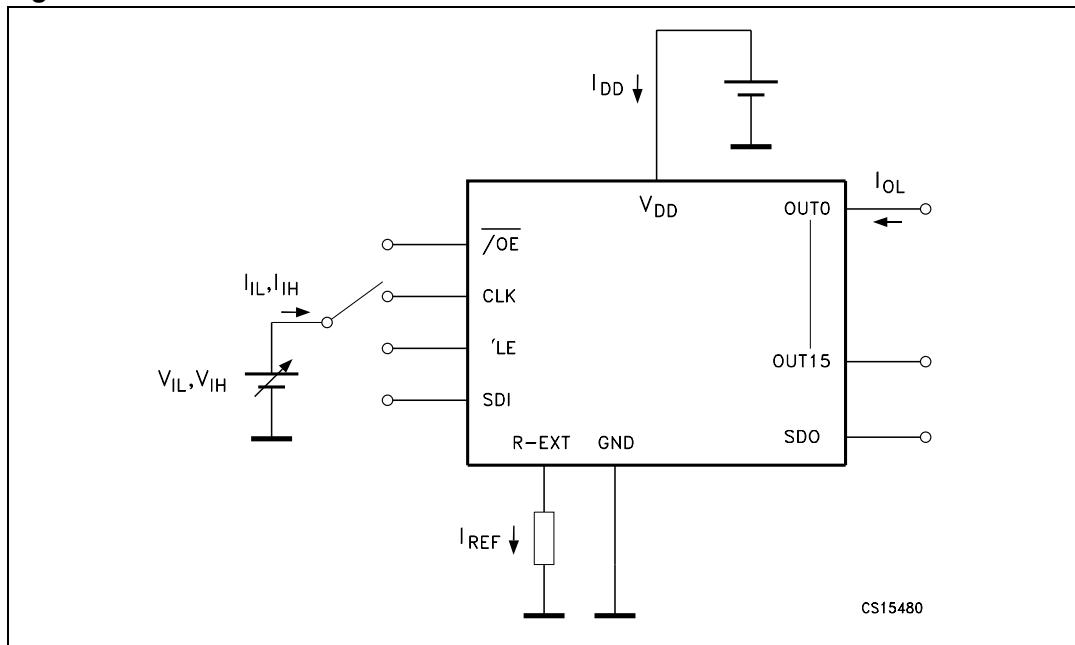
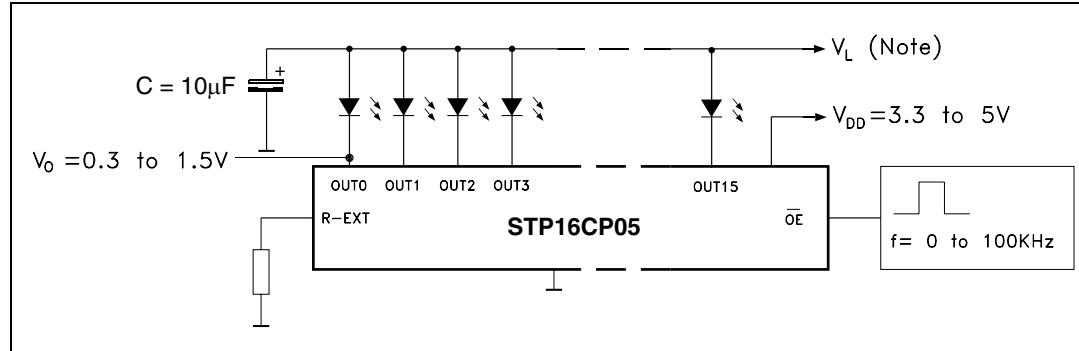
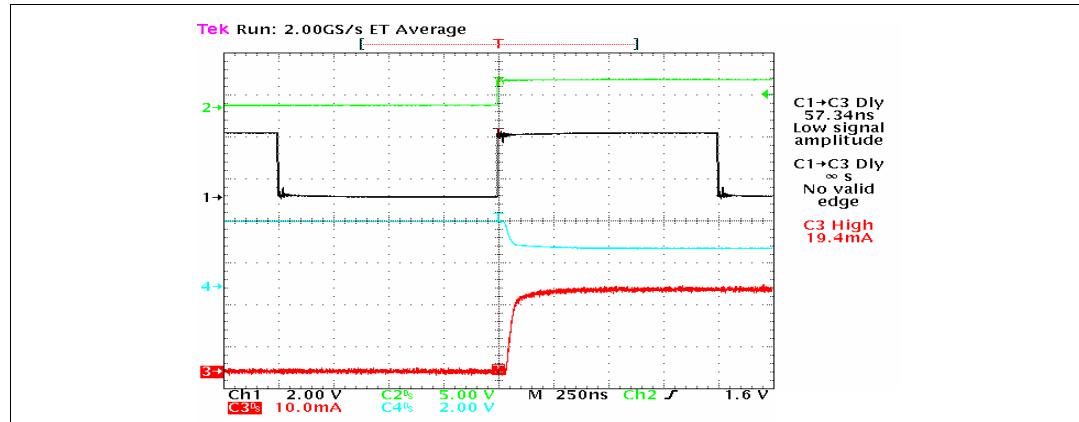
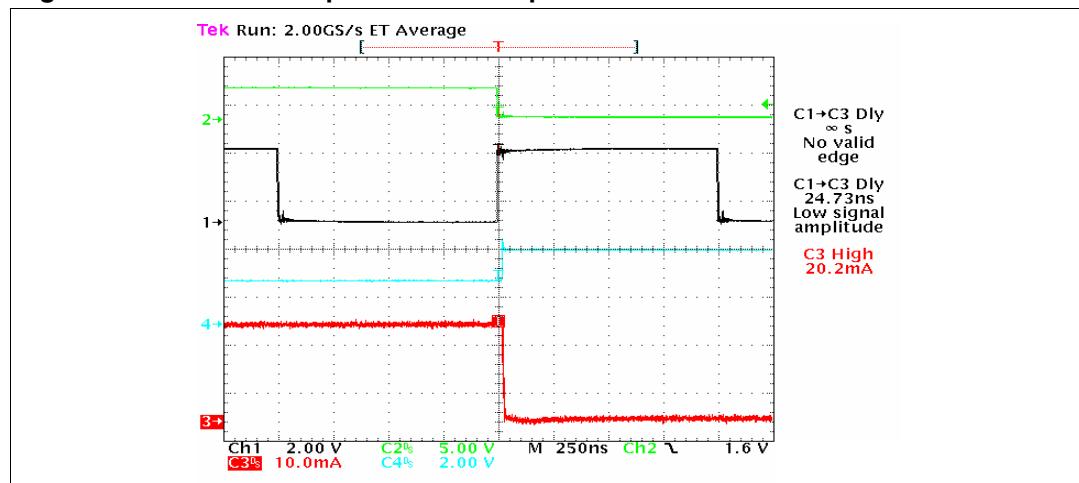


Figure 18. Typical application schematic

Note: V_L will be determined by the V_F of the LEDs

Test condition: Temp. = 25 °C, $V_{DD} = 3.0$ V, $V_{IN} = V_{DD}$, $C_L = 10$ pF, Freq. = 1 MHz,
Ch1 = CLK, Ch2 = SDI, Ch3 = OUTn , Ch4 = V_{OUT}

Figure 19. Turn ON output current setup**Figure 20.** Turn OFF output current setup

8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Table 11. QSOP-24 mechanical data

| Dim. | mm. | | | inch | | |
|------|-------|-------|------|-------|-------|-------|
| | Min | Typ | Max | Min | Typ | Max |
| A | 1.54 | 1.62 | 1.73 | 0.061 | 0.064 | 0.068 |
| A1 | 0.1 | 0.15 | 0.25 | 0.004 | 0.006 | 0.010 |
| A2 | | 1.47 | | | 0.058 | |
| b | 0.31 | 0.2 | | 0.012 | 0.008 | |
| c | 0.254 | 0.17 | | 0.010 | 0.007 | |
| D | 8.56 | 8.66 | 8.76 | 0.337 | 0.341 | 0.345 |
| E | 5.8 | 6 | 6.2 | 0.228 | 0.236 | 0.244 |
| E1 | 3.8 | 3.91 | 4.01 | 0.150 | 0.154 | 0.158 |
| e | | 0.635 | | | 0.025 | |
| L | 0.4 | 0.635 | 0.89 | 0.016 | 0.025 | 0.035 |
| h | 0.25 | 0.33 | 0.41 | 0.010 | 0.013 | 0.016 |
| < | 8° | 0° | | | | |

Figure 21. QSOP-24 package dimensions

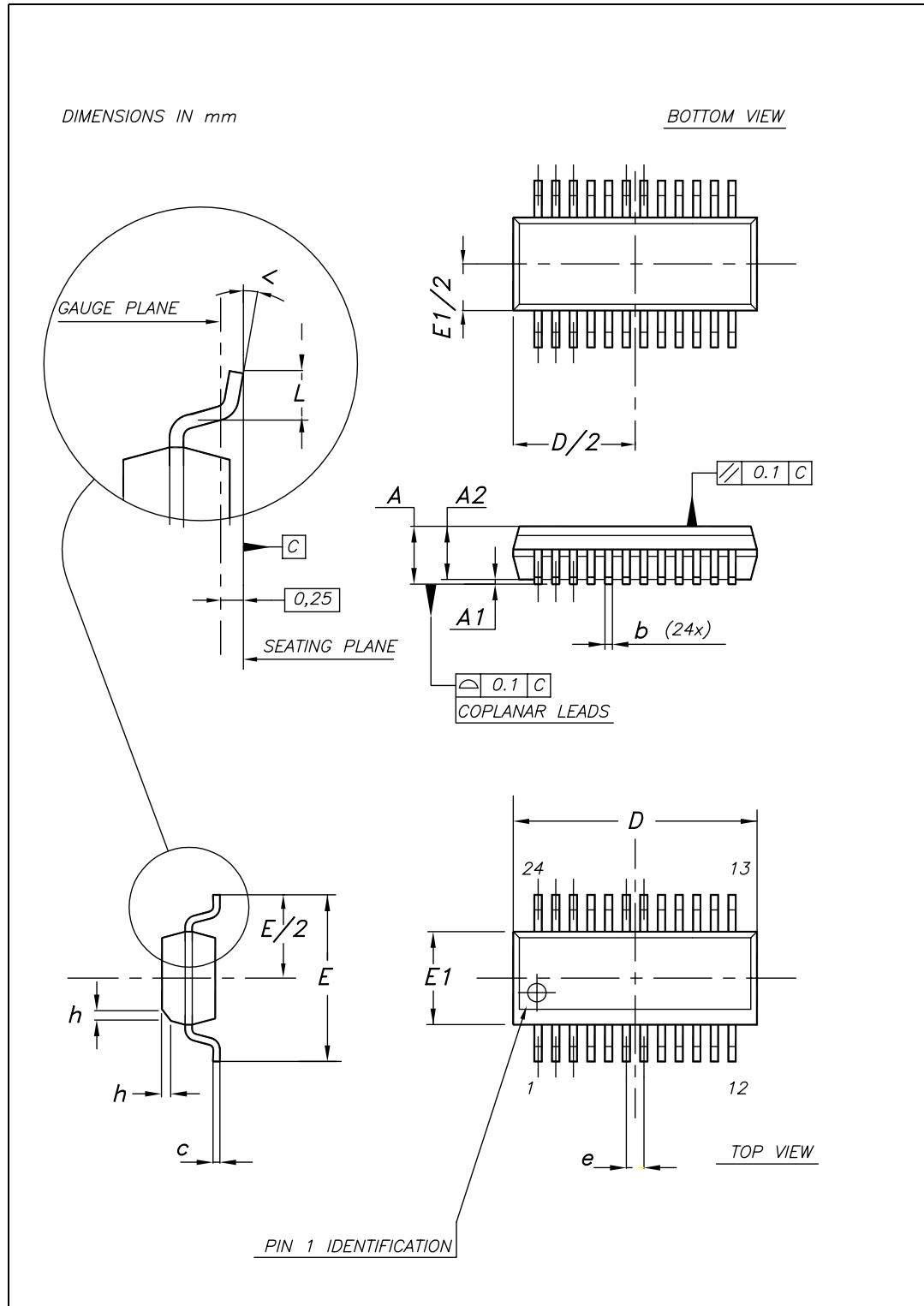


Table 12. TSSOP24 mechanical data

| Dim. | mm. | | | inch | | |
|------|------|----------|------|--------|------------|--------|
| | Min | Typ | Max | Min | Typ | Max |
| A | | | 1.1 | | | 0.043 |
| A1 | 0.05 | | 0.15 | 0.002 | | 0.006 |
| A2 | | 0.9 | | | 0.035 | |
| b | 0.19 | | 0.30 | 0.0075 | | 0.0118 |
| c | 0.09 | | 0.20 | 0.0035 | | 0.0079 |
| D | 7.7 | | 7.9 | 0.303 | | 0.311 |
| E | 4.3 | | 4.5 | 0.169 | | 0.177 |
| e | | 0.65 BSC | | | 0.0256 BSC | |
| H | 6.25 | | 6.5 | 0.246 | | 0.256 |
| K | 0° | | 8° | 0° | | 8° |
| L | 0.50 | | 0.70 | 0.020 | | 0.028 |

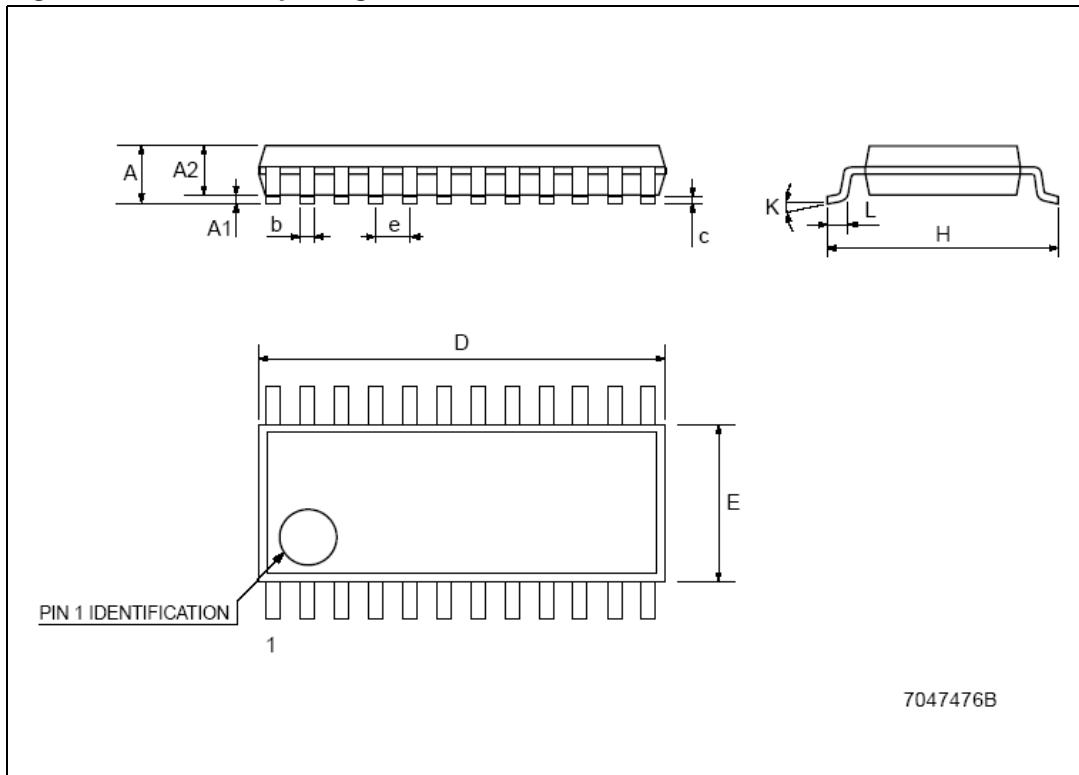
Figure 22. TSSOP24 package dimensions

Table 13. Tape and reel TSSOP24

| Dim. | mm. | | | inch | | |
|------|------|-----|------|-------|-----|--------|
| | Min | Typ | Max | Min | Typ | Max |
| A | | | 330 | | | 12.992 |
| C | 12.8 | | 13.2 | 0.504 | | 0.519 |
| D | 20.2 | | | 0.795 | | |
| N | 60 | | | 2.362 | | |
| T | | | 22.4 | | | 0.882 |
| Ao | 6.8 | | 7 | 0.268 | | 0.276 |
| Bo | 8.2 | | 8.4 | 0.323 | | 0.331 |
| Ko | 1.7 | | 1.9 | 0.067 | | 0.075 |
| Po | 3.9 | | 4.1 | 0.153 | | 0.161 |
| P | 11.9 | | 12.1 | 0.468 | | 0.476 |

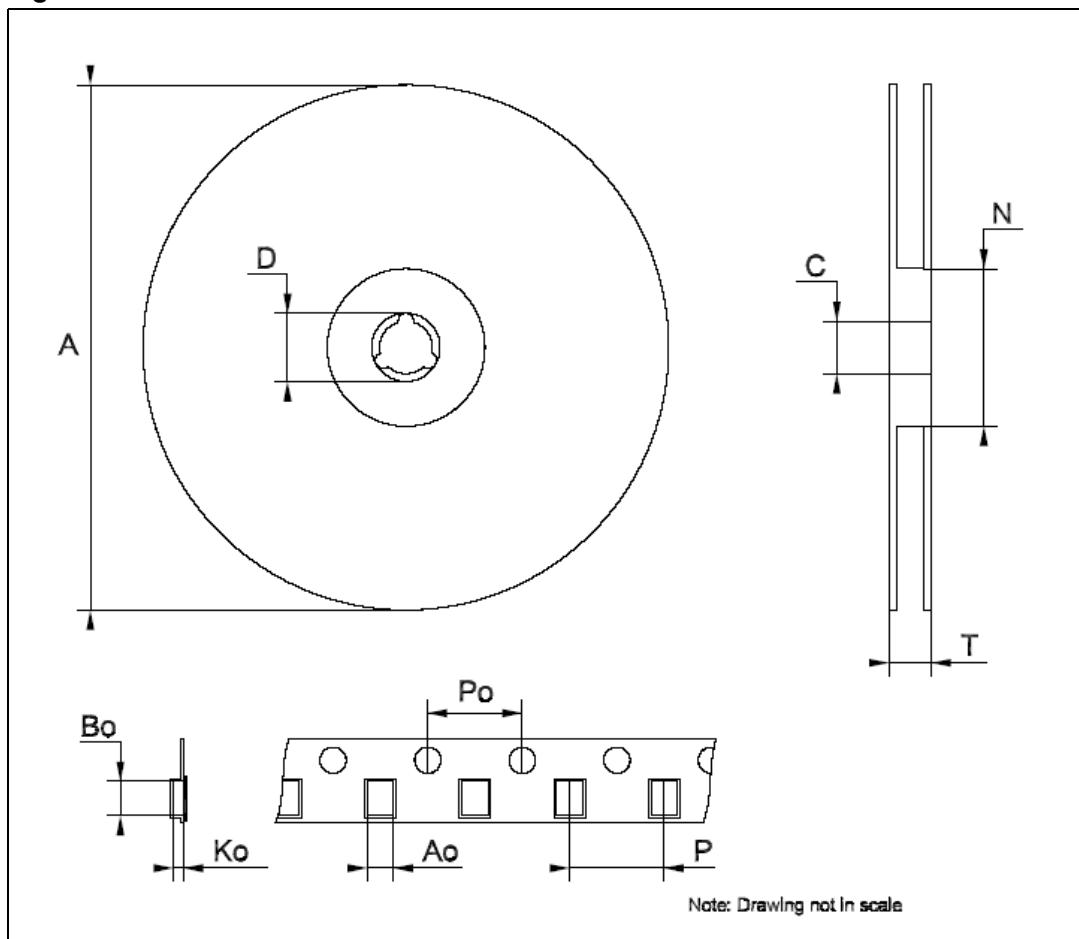
Figure 23. Reel dimensions

Table 14. SO-24 mechanical data

| Dim. | mm. | | | inch | | |
|------|-----------|-------|-------|-------|-------|-------|
| | Min | Typ | Max | Min | Typ | Max |
| A | | | 2.65 | | | 0.104 |
| a1 | 0.1 | | 0.2 | 0.004 | | 0.008 |
| a2 | | | 2.45 | | | 0.096 |
| b | 0.35 | | 0.49 | 0.014 | | 0.019 |
| b1 | 0.23 | | 0.32 | 0.009 | | 0.012 |
| C | | 0.5 | | | 0.020 | |
| c1 | 45°(typ.) | | | | | |
| D | 15.20 | | 15.60 | 0.598 | | 0.614 |
| E | 10.00 | | 10.65 | 0.393 | | 0.419 |
| e | | 1.27 | | | 0.050 | |
| e3 | | 13.97 | | | 0.550 | |
| F | 7.40 | | 7.60 | 0.291 | | 0.300 |
| L | 0.50 | | 1.27 | 0.020 | | 0.050 |
| S | °(max.) 8 | | | | | |

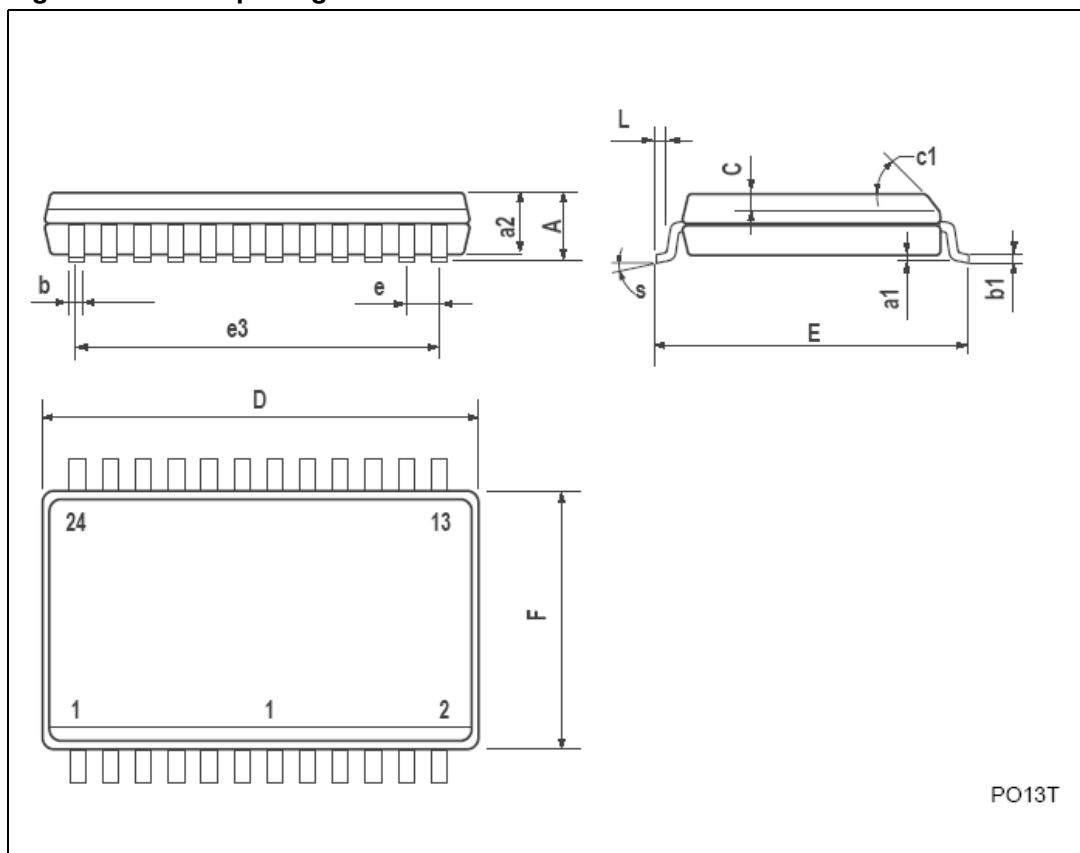
Figure 24. SO-24 package dimensions

Table 15. Tape and reel SO-24

| Dim. | mm. | | | inch | | |
|------|------|-----|------|-------|-----|--------|
| | Min | Typ | Max | Min | Typ | Max |
| A | | | 330 | | | 12.992 |
| C | 12.8 | | 13.2 | 0.504 | | 0.519 |
| D | 20.2 | | | 0.795 | | |
| N | 60 | | | 2.362 | | |
| T | | | 30.4 | | | 1.197 |
| Ao | 10.8 | | 11.0 | 0.425 | | 0.433 |
| Bo | 15.7 | | 15.9 | 0.618 | | 0.626 |
| Ko | 2.9 | | 3.1 | 0.114 | | 0.122 |
| Po | 3.9 | | 4.1 | 0.153 | | 0.161 |
| P | 11.9 | | 12.1 | 0.468 | | 0.476 |

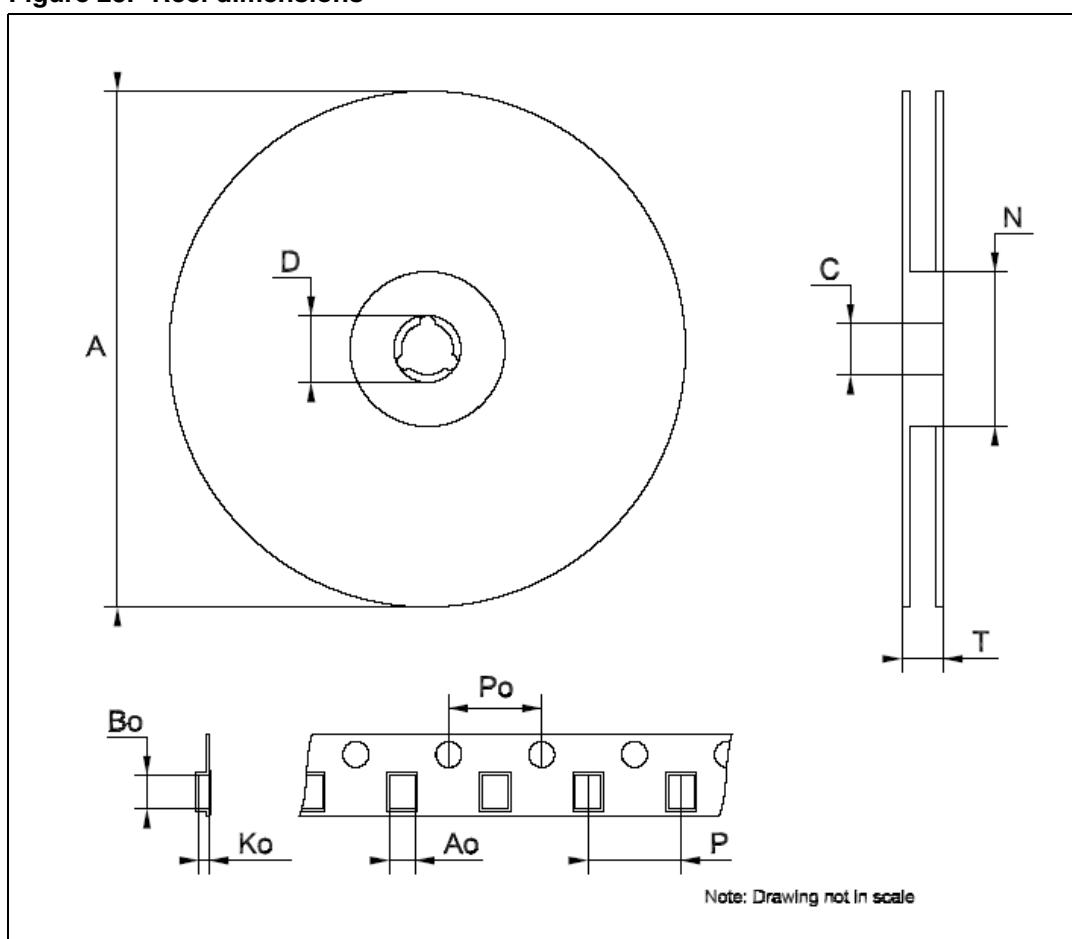
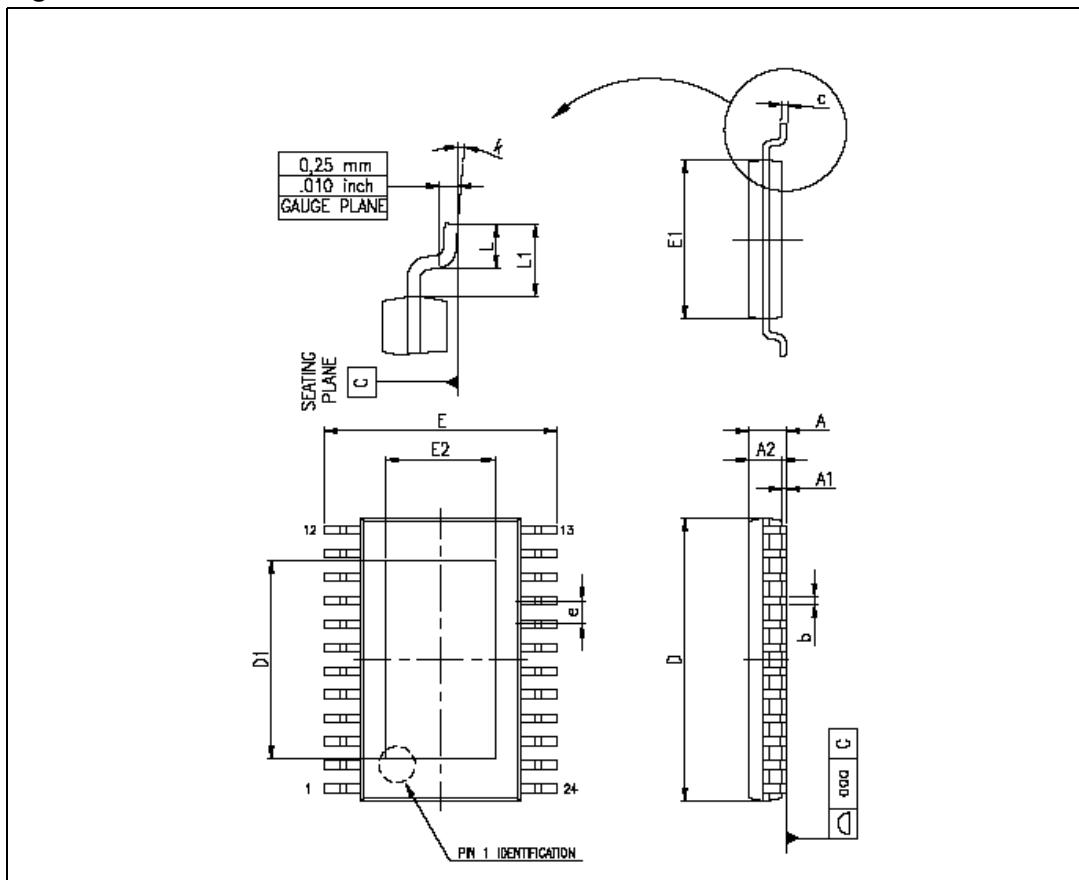
Figure 25. Reel dimensions

Table 16. TSSOP24 exposed-pad

| Dim. | mm | | | inch | | |
|------|------|------|------|-------|--------|--------|
| | Min | Typ | Max | Min | Typ | Max |
| A | | | 1.2 | | | 0.047 |
| A1 | | | 0.15 | | 0.004 | 0.006 |
| | | | | | | |
| A2 | 0.8 | 1 | 1.05 | 0.031 | 0.039 | 0.041 |
| b | 0.19 | | 0.30 | 0.007 | | 0.012 |
| c | 0.09 | | 0.20 | 0.004 | | 0.0089 |
| D | 7.7 | 7.8 | 7.9 | 0.303 | 0.307 | 0.311 |
| D1 | 4.7 | 5.0 | 5.3 | 0.185 | 0.197 | 0.209 |
| E | 6.2 | 6.4 | 6.6 | 0.244 | 0.252 | 0.260 |
| E1 | 4.3 | 4.4 | 4.5 | 0.169 | 0.173 | 0.177 |
| E2 | 2.9 | 3.2 | 3.5 | 0.114 | 0.126 | 0.138 |
| e | | 0.65 | | | 0.0256 | |
| K | 0° | | 8° | 0° | | 8° |
| L | 0.45 | 0.60 | 0.75 | 0.018 | 0.024 | 0.030 |

Figure 26. TSSOP24 dimensions



9 Revision history

Table 17. Revision history

| Date | Revision | Changes |
|-------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| 28-Jul-2006 | 1 | First release |
| 21-Dec-2006 | 2 | Final datasheet |
| 17-May-2007 | 3 | Updated Table 7 on page 6 |
| 10-Jul-2007 | 4 | Updated Table 9: Truth table on page 10 |
| 12-Mar-2008 | 5 | Updated Table 15: TSSOP24 exposed-pad on page 23 , added QSOP-24 Table 11 and Figure 21 on page 19 |
| 07-May-2008 | 6 | Updated Section 5 on page 10 |

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